Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are referenced to Ground lead. (Tambient=25°C unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
Vds	Maximum drain to source voltage	-0.3	36	V
Vds cont	Maximum continuous drain to source voltage	-	28	V
Vin	Maximum input voltage	-0.3	6	V
Isd cont.	Max diode continuous current (limited by thermal dissipation)	—	1.5	A
Pd	Maximum power dissipation (internally limited by thermal protection)			W
	Rth=60°C/W IPS1041L 1" sqr. footprint		2	
	Rth=100°C/W IPS1042G std. footprint		1.25	
ESD	Electrostatic discharge voltage (Human body) C=100pF, R=1500Ω			kV
	Between drain and source	—	4	
	Other combinations	—	3	
	Electrostatic discharge voltage (Machine Model) C=200pF,R=0Ω			
	Between drain and source	—	0.5	
	Other combinations	—	0.3	
Tj max.	Max. storage & operating temperature junction temperature	-40	150	°C
Tsoldering	Lead soldering temperature (10 seconds)	—	300	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
Rth1	Thermal resistance junction to ambient IPS1041L SOT-223 std. footprint	100	—	°C/W
Rth2	Thermal resistance junction to ambient IPS1041L SOT-223 1" sqr. footprint	60	—	
Rth1	Thermal resistance junction to ambient IPS1041R D-Pak std. footprint	70	—	
Rth2	Thermal resistance junction to case IPS1041R D-Pak	6	—	
Rth1	Thermal resistance junction to ambient IPS1042G SO-8 std. Footprint 1 die active	100	—	
Rth1	Thermal resistance junction to ambient IPS1042G SO-8 std. footprint 2 die active	130	—	

Recommended Operating Conditions

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
VIH	High level input voltage	4.5	5.5	V
VIL	Low level input voltage	0	0.5	
Ids	Continuous drain current, Tambient=85°C, Tj=125°C, Vin=5V Rth=60°C/W IPS1041L 1" sqr. Footprint	—	1.95	A
	Continuous drain current, Tambient=85°C, Tj=125°C, Vin=5V Rth=50°C/W IPS1041R 1" sqr. Footprint	—	2.2	
	Continuous drain current, Tambient=85°C, Tj=125°C, Vin=5V Rth=100°C/W IPS1042G 1" sqr. Footprint - 1 die active	—	1.5	
	Continuous drain current, Tambient=85°C, Tj=125°C, Vin=5V Rth=130°C/W IPS1042G 1" sqr. Footprint - 2 die active		0.7	
Rin	Recommended resistor in series with IN pin to generate a diagnostic	0.5	10	kΩ
Max L	Max. recommended load inductance (including line inductance) (1)	—	20	µH
Max. F	Max. frequency	—	2000	Hz
Max. t rise	Max. input rising time	—	1	µs

(1) Higher inductance is possible if maximum load current is limited - see figure 11

Static Electrical Characteristics

Tj=25°C, Vcc=14V (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Rds(on)	ON state resistance Tj=25°C	—	80	100	mΩ	Vin=5V, Ids=3A
	ON state resistance Tj=150°C	—	135	175		
Idss1	Drain to source leakage current	—	0.1	5	µA	Vcc=14V, Tj=25°C
Idss2	Drain to source leakage current	—	0.2	10		Vcc=28V, Tj=25°C
V clamp1	Drain to source clamp voltage 1	36	38	—	V	Id=10mA
V clamp2	Drain to source clamp voltage 2	—	39	42		Id=1A
Vin clamp	IN to source pin clamp voltage	5.5	6.5	7.5		Iin=1mA
Vth	Input threshold voltage	—	1.7	—		Id=10mA

Switching Electrical Characteristics

Vcc=14V, Resistive load=5Ω, Rinput=0Ω, Vin=5V, Tj=25°C

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Tdon	Turn-on delay time to 20%	3	10	23	µs	See figure 2
Tr	Rise time 20% to 80%	2	7	20		
Tdoff	Turn-off delay time to 80%	15	40	150		
Tf	Fall time 80% to 20%	4	10	20		
Eon + Eoff	Turn on and off energy	—	0.2	—	mJ	

Protection Characteristics

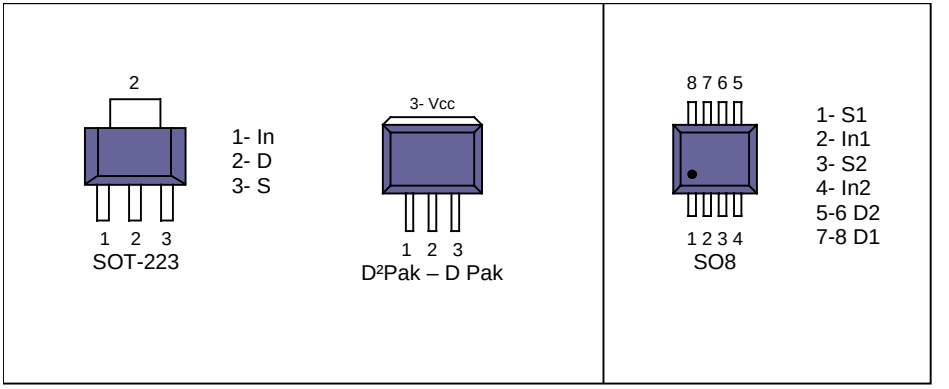
Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Tsd	Over temperature threshold	150(2)	165	—	°C	See figure 1
Isd	Over current threshold	3	4.5	6	A	See figure 1
OV	Over voltage protection (not active when the device is ON)	34	37	—	V	
Vreset	IN protection reset threshold	—	1.7	—	V	
Treset	Time to reset protection	15(2)	50	200	µs	Vin=0V, Tj=25°C

(2) Guaranteed by design

Diagnostic

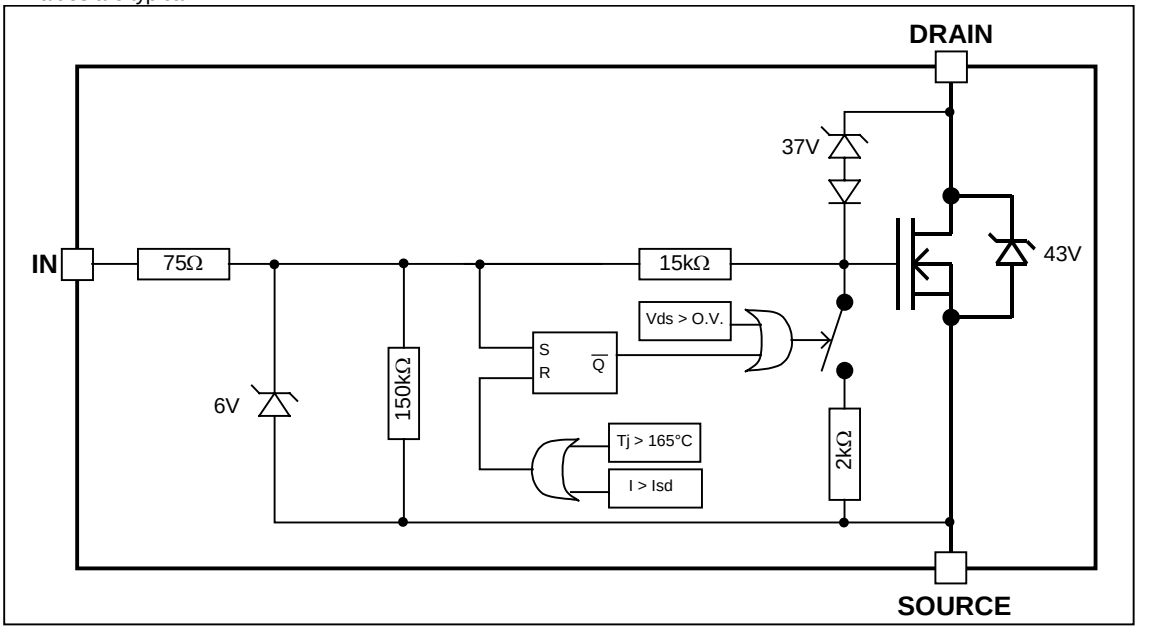
Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
Iin, on	ON state IN positive current	15	32	70	µA	Vin=5V
Iin, off	OFF state IN positive current (after protection latched)	150	230	350		Vin=5V

Lead Assignments



Functional Block Diagram

All values are typical



All curves are typical values. Operating in the shaded area is not recommended.

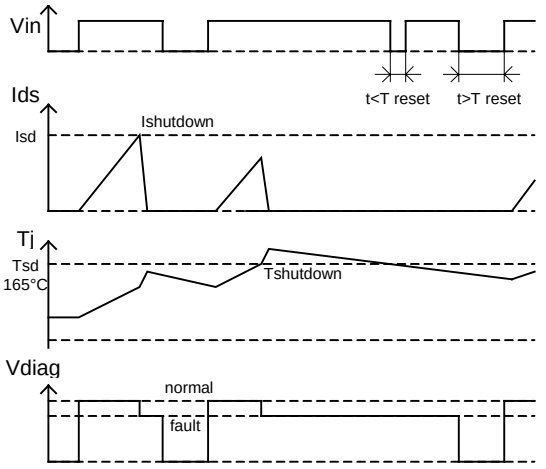


Figure 1 – Timing diagram

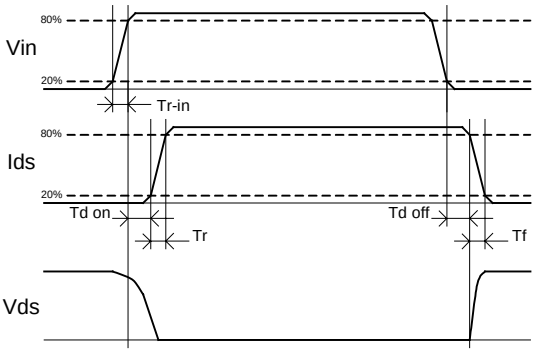
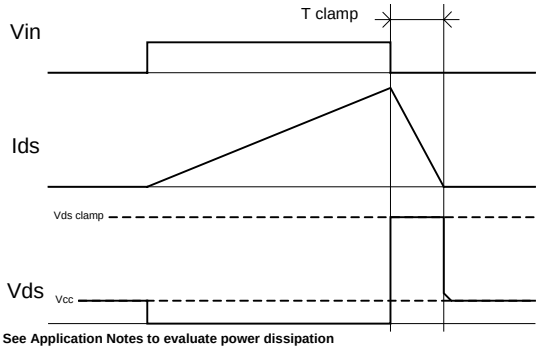


Figure 2 – IN rise time & switching definitions



See Application Notes to evaluate power dissipation

Figure 3 – Active clamp waveforms

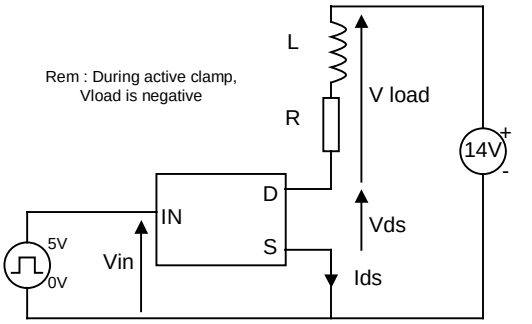


Figure 4 – Active clamp test circuit

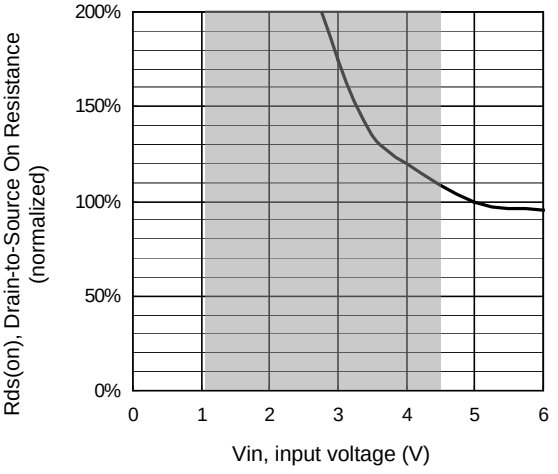


Figure 5 – Normalized Rds(on) (%) Vs Input voltage (V)

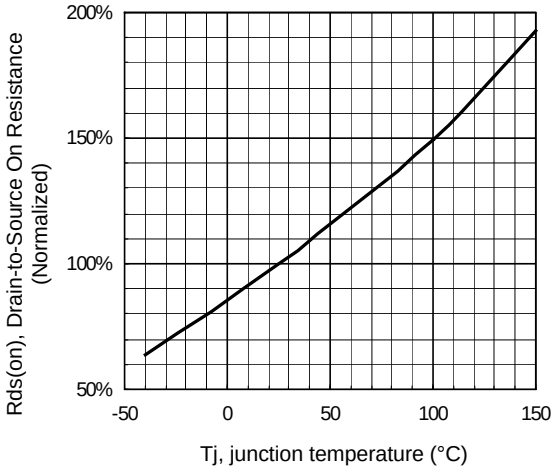


Figure 6 - Normalized Rds(on) (%) Vs Tj (°C)

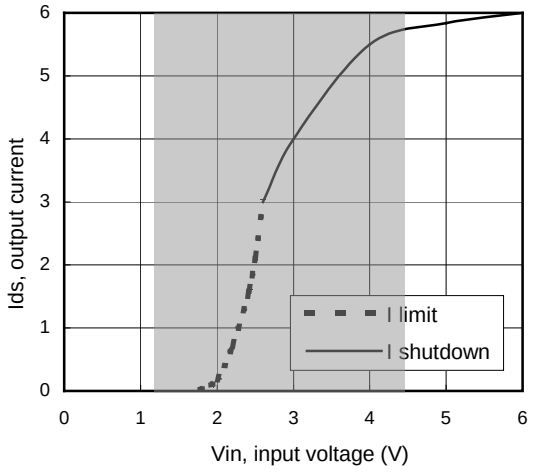


Figure 7 – Current limitation and current shutdown Vs Input voltage (V)

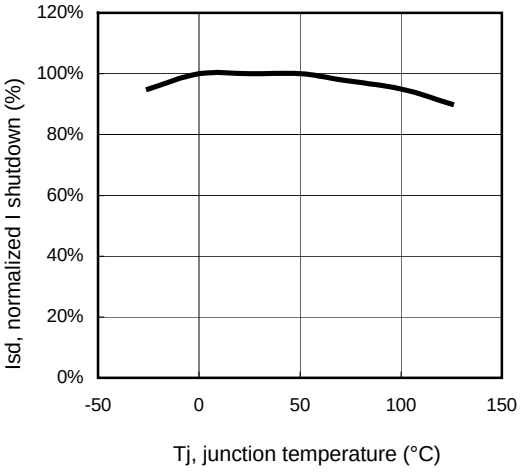


Figure 8 – Normalized I shutdown (%) Vs junction temperature (°C)

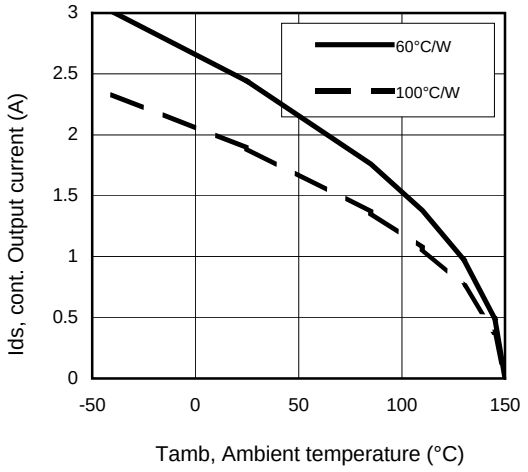


Figure 9 – Max. continuous output current (A) Vs Ambient temperature (°C)

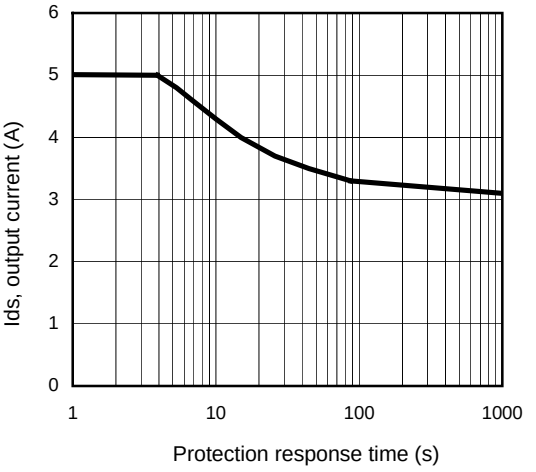


Figure 10 – Ids (A) Vs over temperature protection response time (s) / IPS1041L

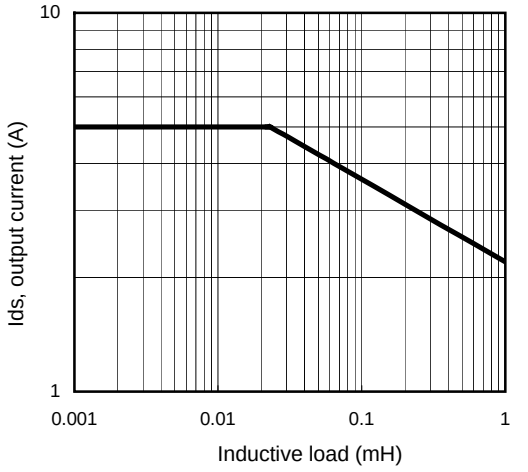


Figure 11 – Max. ouput current (A) Vs Inductive load (mH)

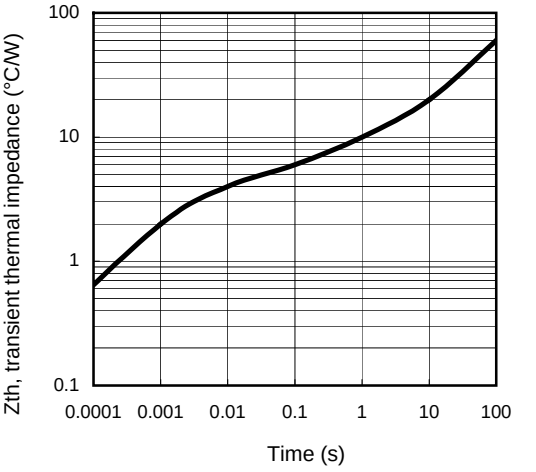


Figure 12 – Transient thermal impedance (°C/W) Vs time (s)

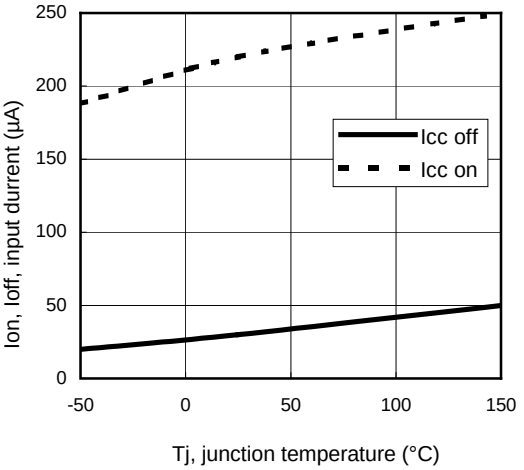


Figure 13 – Input current (µA) On and Off Vs junction temperature (°C)

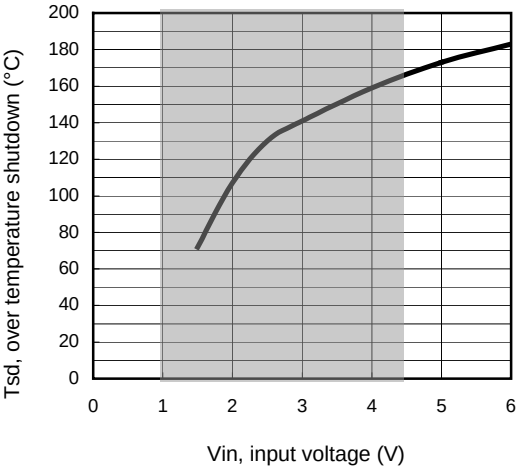
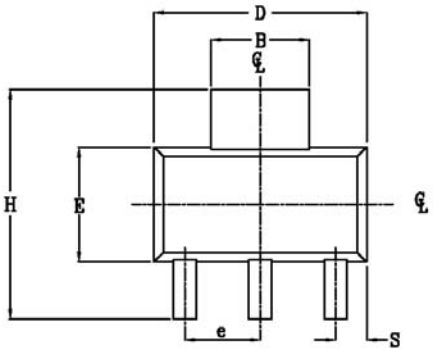


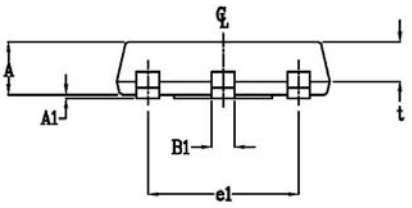
Figure 14 – Over temperature shutdown (°C) Vs input voltage (V)

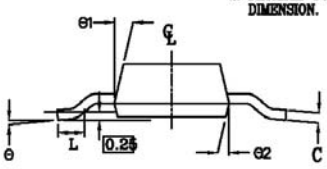
Case Outline - SOT-223 - Automotive Q100 PbF MSL2 qualified



POS	MILLIMETERS		INCHES	
	MAX	MIN	MAX	MIN
A	1.70	1.50	.067	.060
A1	0.10	0.02	.004	.0008
B	3.15	2.95	.124	.116
B1	0.85	0.65	.033	.026
C	0.35	0.25	.014	.010
D	6.70	6.30	.264	.248
e	2.30 NOM		.0905 NOM	
e1	4.60 NOM		.181 NOM	
E	3.70	3.30	.146	.130
H	7.30	6.70	.287	.264
S	1.05	0.85	.041	.033
t	1.30	1.10	.051	.043
Θ	10° MAX		10° MAX	
Θ1	16°	10°	16°	10°
Θ2	16°	10°	16°	10°
L	0.75 MIN		0.0295 MIN	

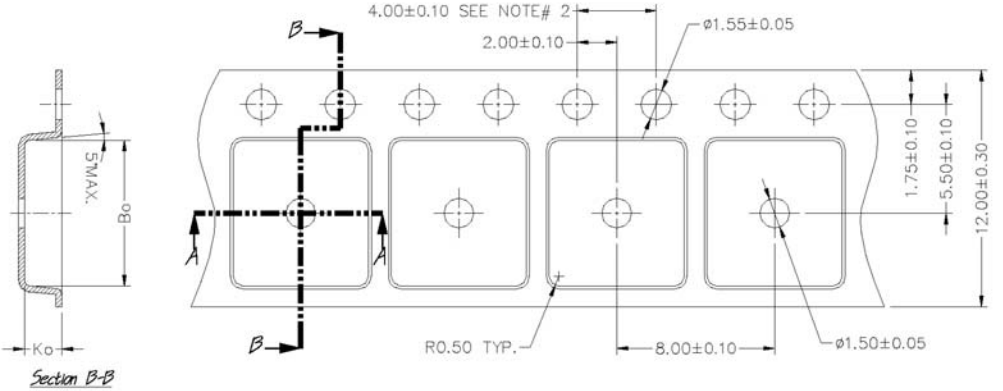
NOTE:
1. PACKAGE OUTLINE EXCLUSIVE OF ANY MOLD FLASHES DIMENSION.
2. PACKAGE OUTLINE EXCLUSIVE OF BURR DIMENSION.





Leads and drain are plated with 100% Sn

Tape & Reel - SOT-223

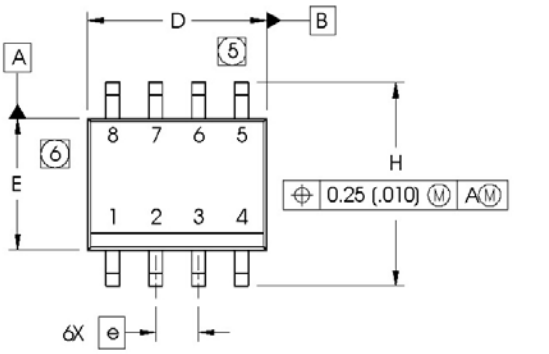


NOTES:
1. Ao & Bo are measured at 0.3mm above base of packet.
2. 10 picthes cumulative tol. ±0.2mm.

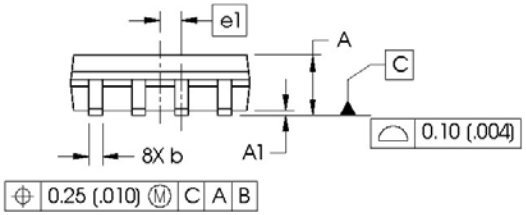
Ao:	*6.85*
Bo:	*7.40*
Ko:	*1.90*
Pitch:	*8.00*
Width:	*12.00*

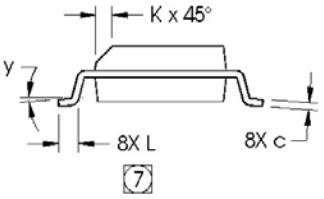
Case Outline - SO-8 - Automotive Q100 PbF MSL2 qualified

Dimensions are shown in millimeters (inches)



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050 BASIC		1.27 BASIC	
e1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°





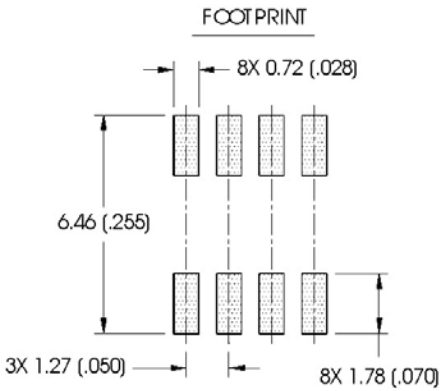
NOTES:

1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.

(5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).

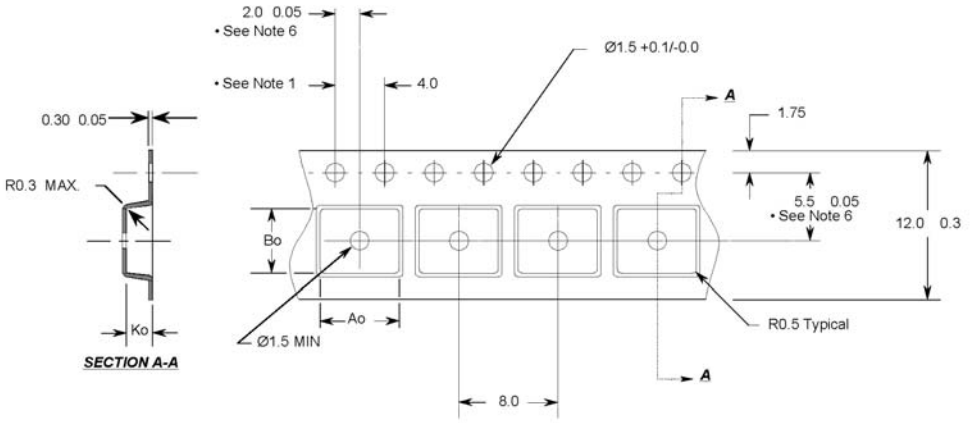
(6) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).

(7) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.



Leads and drain are plated with 100% Sn

Tape & Reel - SO-8

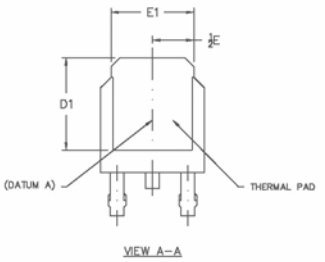


Notes:
1. 10 sprocket hole pitch cumulative tolerance 0.2
2. Camber not to exceed 1mm in 100mm
3. Material: Black Conductive Advantek Polystyrene
4. Ao and Bo measured on a plane 0.3mm above the bottom of the pocket
5. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

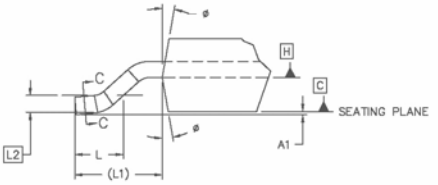
Ao = 6.4 mm
Bo = 5.2 mm
Ko = 2.1 mm

- All Dimensions in Millimeters -

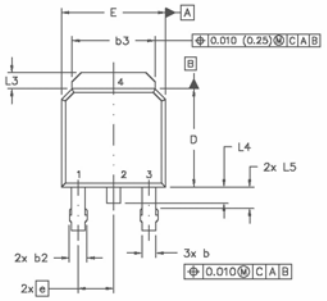
Case Outline – D-Pak - Automotive Q100 PbF MSL1 qualified



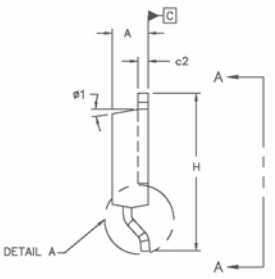
VIEW A–A

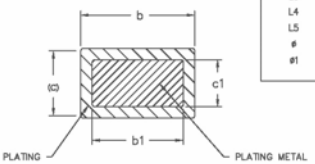


DETAIL "A"
ROTATED 90°



SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	2.18	2.39	.086	.094	
A1		0.13		.005	
b	0.64	0.89	.025	.035	5
b1	0.64	0.79	.025	0.031	5
b2	0.76	1.14	.030	.045	
b3	4.95	5.46	.195	.215	
c	0.46	0.61	.018	.024	5
c1	0.41	0.56	.016	.022	5
c2	.046	0.89	.018	.035	5
D	5.97	6.22	.235	.245	6
D1	5.21	–	.205	–	4
E	6.35	6.73	.250	.265	6
E1	4.32	–	.170		4
e	2.29		.090 BSC		
H	9.40	10.41	.370	.410	
L	1.40	1.78	.055	.070	
L1	2.74 REF.		.108 REF.		
L2	0.051 BSC		.020 BSC		
L3	0.89	1.27	.035	.050	
L4		1.02		.040	
L5	1.14	1.52	.045	.060	3
ø	0°	10°	0°	10°	
ø1	0°	15°	0°	15°	





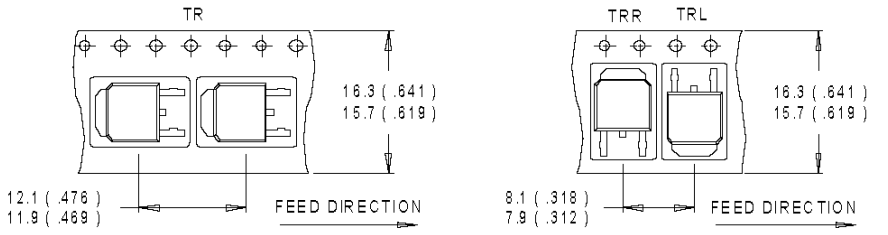
SECTION C–C

NOTES:

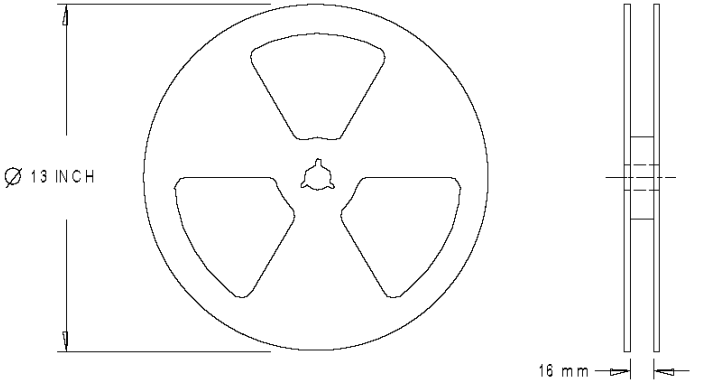
1.0 DIMENSIONING AND TOLERANCING PER ASME Y14.5 M– 1994.
2.0 DIMENSIONS ARE SHOWN IN INCHES [MILLIMETERS].
3.0 LEAD DIMENSION UNCONTROLLED IN L5
4.0 DIMENSION D1 AND E1 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
5.0 SECTION C–C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 [0.127] AND .010 [0.2540 FROM THE LEAD TIP.
6.0 DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005" (0.127) PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY.
7.0 OUTLINE CONFORMS TO JEDEC OUTLINE TO–252AA.

8.0 LEADS AND DRAIN ARE PLTED WITH 100% Sn

Tape & Reel - D-Pak



NOTES :
1. CONTROLLING DIMENSION : MILLIMETER.
2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES :
1. OUTLINE CONFORMS TO EIA-481.

Dimensions are shown in millimeters (inches)

IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245 Tel: (310) 252-7105

Data and specifications subject to change without notice.
Dpak is MSL1 qualified.
SOT223 and SO8 are MSL2 qualified.
This product is designed and qualified for the Automotive [Q100] market. 12/06/2006